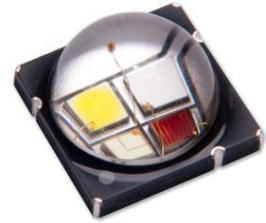


# High Luminous Efficacy RGBW pin aligned LED Emitter **LZ4-00MD06**



## Key Features

- High Luminous Efficacy 4-die RGBW LED
- Individually addressable Red, Green, Blue and Daylight White die
- Anodes and Cathodes are aligned for easy connection of multiple emitters
- Electrically neutral thermal path
- Ultra-small foot print – 7.0mm x 7.0mm
- Surface mount ceramic package with integrated dome lens
- Very low Thermal Resistance (1.1°C/W)
- Very high Luminous Flux density
- New industry standard for Lumen Maintenance (>90% at 65,000 Hours)
- JEDEC Level 1 for Moisture Sensitivity Level
- Autoclave compliant (JEDEC JESD22-A102-C)
- Lead (Pb) free and RoHS compliant
- Reflow solderable (up to 6 cycles)
- Emitter available on Standard MCPCB (optional)

## Typical Applications

- Architectural Lighting
- Retail Spot and Display Lighting
- Stage and Studio Lighting
- Hospitality Lighting
- Museum Lighting
- Video Walls and Full Color Displays

## Description

The LZ4-00MD06 RGBW LED emitter contains one red, green, blue and daylight white LED die which provides 10W power in an extremely small package. With a 7.0mm x 7.0mm ultra-small footprint, this package allows close proximity to the LED die for optical systems designs that require imaging optics. LED Engin's RGBW LED offers ultimate design flexibility with individually addressable die. The LZ4-00MD06 is capable of producing a continuous spectrum of white light plus millions of colors. The patented design has unparalleled thermal and optical performance. The high quality materials used in the package are chosen to optimize light output and minimize stresses which results in monumental reliability and lumen maintenance. The robust product design thrives in outdoor applications with high ambient temperatures and high humidity.

## Part number options

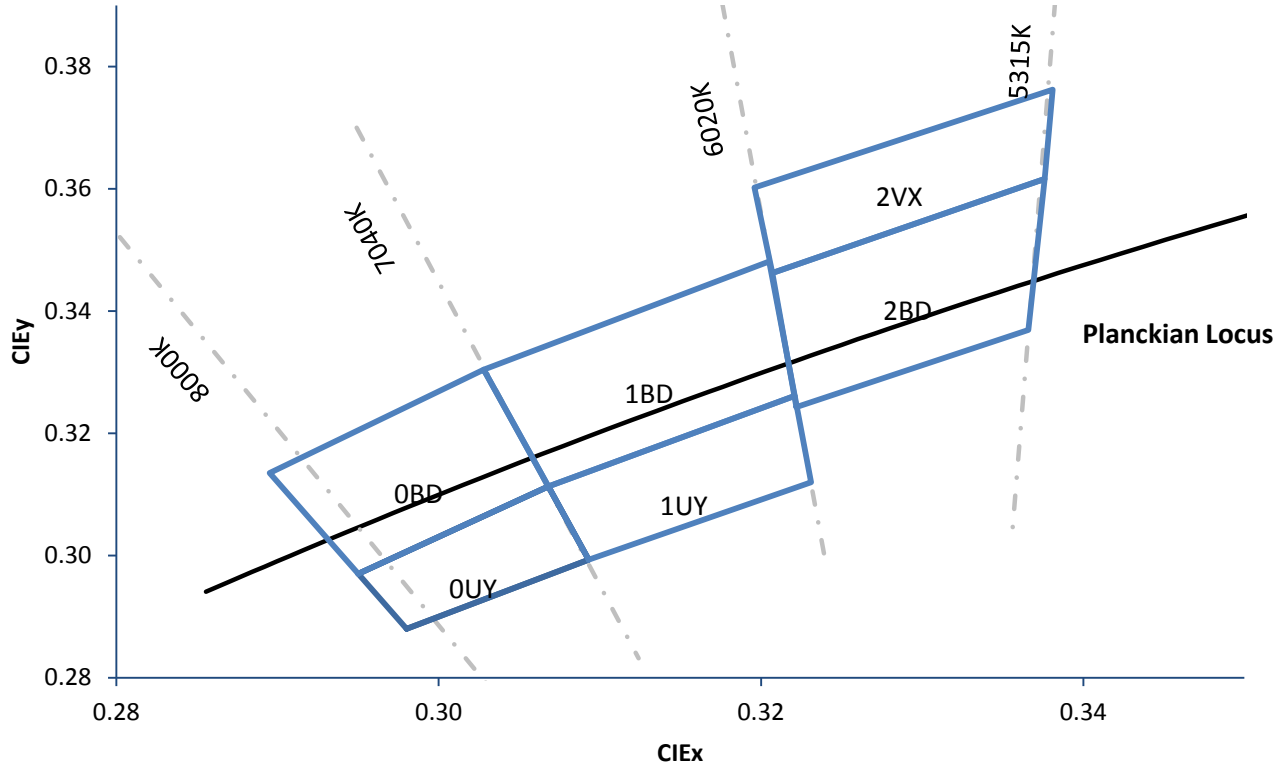
### Base part number

| Part number     | Description                  |
|-----------------|------------------------------|
| LZ4-00MD06-xxxx | LZ4 RGBW emitter pin aligned |

### Bin kit option codes

| MD, Red-Green-Blue-White (5000K – 6500K) |              |                              |                                                             |
|------------------------------------------|--------------|------------------------------|-------------------------------------------------------------|
| Kit number suffix                        | Min flux Bin | Color Bin Ranges             | Description                                                 |
| 0000                                     | 01R          | R2 – R2                      | Red, full distribution flux; full distribution wavelength   |
|                                          | 01G          | G2 – G3                      | Green, full distribution flux; full distribution wavelength |
|                                          | 01B          | B01 – B02                    | Blue, full distribution flux; full distribution wavelength  |
|                                          | 01W          | 0bd, 0uy, 1bd, 1uy, 2vx, 2bd | White full distribution flux and CCT                        |

## Daylight White Chromaticity Groups



Standard Chromaticity Groups plotted on excerpt from the CIE 1931 (2°) x-y Chromaticity Diagram. Coordinates are listed below in Table 5.

## Cool White Bin Coordinates

| Bin Code | CIE x  | CIE y  | Bin Code | CIE x  | CIE y  | Bin Code | CIE x  | CIE y  |
|----------|--------|--------|----------|--------|--------|----------|--------|--------|
| OBD      | 0.295  | 0.297  | 1BD      | 0.3068 | 0.3113 | 2VX      | 0.3207 | 0.3462 |
|          | 0.2895 | 0.3135 |          | 0.3028 | 0.3304 |          | 0.3196 | 0.3602 |
|          | 0.3028 | 0.3304 |          | 0.3205 | 0.3481 |          | 0.3381 | 0.3762 |
|          | 0.3068 | 0.3113 |          | 0.3221 | 0.3261 |          | 0.3376 | 0.3616 |
|          | 0.295  | 0.297  |          | 0.3068 | 0.3113 |          | 0.3207 | 0.3462 |
| OUY      | 0.298  | 0.288  | 1UY      | 0.3093 | 0.2993 | 2BD      | 0.3222 | 0.3243 |
|          | 0.295  | 0.297  |          | 0.3068 | 0.3113 |          | 0.3207 | 0.3462 |
|          | 0.3068 | 0.3113 |          | 0.3221 | 0.3261 |          | 0.3376 | 0.3616 |
|          | 0.3093 | 0.2993 |          | 0.3231 | 0.312  |          | 0.3366 | 0.3369 |
|          | 0.298  | 0.288  |          | 0.3093 | 0.2993 |          | 0.3222 | 0.3243 |

## Luminous Flux Bins

Table 1:

| Bin Code | Minimum<br>Luminous Flux ( $\Phi_v$ )<br>@ $I_F = 700\text{mA}$ <sup>[1,2]</sup><br>(lm) |         |        |         | Maximum<br>Luminous Flux ( $\Phi_v$ )<br>@ $I_F = 700\text{mA}$ <sup>[1,2]</sup><br>(lm) |         |        |         |
|----------|------------------------------------------------------------------------------------------|---------|--------|---------|------------------------------------------------------------------------------------------|---------|--------|---------|
|          | 1 Red                                                                                    | 1 Green | 1 Blue | 1 White | 1 Red                                                                                    | 1 Green | 1 Blue | 1 White |
|          |                                                                                          |         |        |         |                                                                                          |         |        |         |
| 01R      | 65                                                                                       |         |        |         | 105                                                                                      |         |        |         |
| 01G      |                                                                                          | 125     |        |         |                                                                                          | 170     |        |         |
| 01B      |                                                                                          |         | 17     |         |                                                                                          |         | 27     |         |
| 02B      |                                                                                          |         | 27     |         |                                                                                          |         | 43     |         |
| 01W      |                                                                                          |         |        | 155     |                                                                                          |         |        | 225     |

Notes for Table 1:

1. Luminous flux performance guaranteed within published operating conditions. LED Engin maintains a tolerance of  $\pm 10\%$  on flux measurements.
2. Future products will have even higher levels of radiant flux performance. Contact LED Engin Sales for updated information.

## Dominant Wavelength Bins

Table 2:

| Bin Code | Minimum<br>Dominant Wavelength ( $\lambda_D$ )<br>@ $I_F = 700\text{mA}$ <sup>[1]</sup><br>(nm) |         |        | Maximum<br>Dominant Wavelength ( $\lambda_D$ )<br>@ $I_F = 700\text{mA}$ <sup>[1]</sup><br>(nm) |         |        |
|----------|-------------------------------------------------------------------------------------------------|---------|--------|-------------------------------------------------------------------------------------------------|---------|--------|
|          | 1 Red                                                                                           | 1 Green | 1 Blue | 1 Red                                                                                           | 1 Green | 1 Blue |
|          |                                                                                                 |         |        |                                                                                                 |         |        |
| R2       | 618                                                                                             |         |        | 630                                                                                             |         |        |
| G2       |                                                                                                 | 520     |        |                                                                                                 | 525     |        |
| G3       |                                                                                                 | 525     |        |                                                                                                 | 530     |        |
| B01      |                                                                                                 |         | 452    |                                                                                                 |         | 457    |
| B02      |                                                                                                 |         | 457    |                                                                                                 |         | 462    |

Notes for Table 2:

1. LED Engin maintains a tolerance of  $\pm 1.0\text{nm}$  on dominant wavelength measurements.

## Forward Voltage Bin

Table 3:

| Bin Code | Minimum<br>Forward Voltage ( $V_F$ )<br>@ $I_F = 700\text{mA}$ <sup>[1]</sup><br>(V) |         |        |         | Maximum<br>Forward Voltage ( $V_F$ )<br>@ $I_F = 700\text{mA}$ <sup>[1]</sup><br>(V) |         |        |         |
|----------|--------------------------------------------------------------------------------------|---------|--------|---------|--------------------------------------------------------------------------------------|---------|--------|---------|
|          | 1 Red                                                                                | 1 Green | 1 Blue | 1 White | 1 Red                                                                                | 1 Green | 1 Blue | 1 White |
|          |                                                                                      |         |        |         |                                                                                      |         |        |         |
| 0        | 2.10                                                                                 | 3.20    | 3.20   | 3.20    | 3.20                                                                                 | 4.20    | 4.00   | 4.00    |

Notes for Table 3:

1. LED Engin maintains a tolerance of  $\pm 0.04\text{V}$  on forward voltage measurements.

## Absolute Maximum Ratings

Table 4:

| Parameter                                                     | Symbol    | Value                                                     | Unit               |
|---------------------------------------------------------------|-----------|-----------------------------------------------------------|--------------------|
| DC Forward Current $T_i = 150^{\circ}\text{C}$                | $I_F$     | 1000                                                      | mA                 |
| DC Forward Current <sup>[1]</sup> $T_i = 130^{\circ}\text{C}$ | $I_F$     | 1200                                                      | mA                 |
| Peak Pulsed Forward Current <sup>[2]</sup>                    | $I_{FP}$  | 1500                                                      | mA                 |
| Reverse Voltage                                               | $V_R$     | See Note 3                                                | V                  |
| Storage Temperature                                           | $T_{std}$ | -40 ~ +150                                                | $^{\circ}\text{C}$ |
| Junction Temperature                                          | $T_J$     | 150                                                       | $^{\circ}\text{C}$ |
| Soldering Temperature <sup>[4]</sup>                          | $T_{sol}$ | 260                                                       | $^{\circ}\text{C}$ |
| Allowable Reflow Cycles                                       |           | 6                                                         |                    |
| Autoclave Conditions <sup>[5]</sup>                           |           | 121 $^{\circ}\text{C}$ at 2 ATM,<br>100% RH for 168 hours |                    |
| ESD Sensitivity <sup>[6]</sup>                                |           | > 8,000 V HBM<br>Class 3B JESD22-A114-D                   |                    |

Notes for Table 4:

- Maximum DC forward current is determined by the overall thermal resistance and ambient temperature. Follow the curves in Figure 12 for current derating. Max current for continues operation is 1.0A
- Pulse forward current conditions: Pulse Width  $\leq 10\text{msec}$  and Duty Cycle  $\leq 10\%$ .
- LEDs are not designed to be reversing biased.
- Solder conditions per JEDEC 020D. See Reflow Soldering Profile Figure 4.
- Autoclave Conditions per JEDEC JESD22-A102-C.
- LED Engin recommends taking reasonable precautions towards possible ESD damages and handling the emitter in an electrostatic protected area (EPA). An EPA may be adequately protected by ESD controls as outlined in ANSI/ESD S6.1.

## Optical Characteristics @ $T_c = 25^{\circ}\text{C}$

Table 5:

| Parameter                                | Symbol                  | Typical |       |                     |       | Unit    |
|------------------------------------------|-------------------------|---------|-------|---------------------|-------|---------|
|                                          |                         | Red     | Green | Blue <sup>[1]</sup> | White |         |
| Luminous Flux (@ $I_F = 700\text{mA}$ )  | $\Phi_V$                | 85      | 140   | 30                  | 170   | lm      |
| Luminous Flux (@ $I_F = 1000\text{mA}$ ) | $\Phi_V$                | 110     | 180   | 40                  | 222   | lm      |
| Dominant Wavelength                      |                         | 623     | 523   | 460                 |       |         |
| Correlated Color Temperature             | CCT                     |         |       |                     | 5500  | K       |
| Color Rendering Index (CRI)              | $R_a$                   |         |       |                     | 75    |         |
| Viewing Angle <sup>[2]</sup>             | $2\theta_{\frac{1}{2}}$ |         | 95    |                     |       |         |
| Total Included Angle <sup>[3]</sup>      | $\theta_{0.9}$          |         | 115   |                     |       | Degrees |

Notes for Table 5:

- When operating the Blue LED, observe IEC 60825-1 class 2 rating. Do not stare into the beam.
- Viewing Angle is the off axis angle from emitter centerline where the luminous intensity is  $\frac{1}{2}$  of the peak value.
- Total Included Angle is the total angle that includes 90% of the total luminous flux.

## Electrical Characteristics @ $T_c = 25^{\circ}\text{C}$

Table 6:

| Parameter                                  | Symbol                    | Typical |       |      |       | Unit                        |
|--------------------------------------------|---------------------------|---------|-------|------|-------|-----------------------------|
|                                            |                           | Red     | Green | Blue | White |                             |
| Forward Voltage (@ $I_F = 700\text{mA}$ )  | $V_F$                     | 2.2     | 3.35  | 3.2  | 3.2   | V                           |
| Temperature Coefficient of Forward Voltage | $\Delta V_F / \Delta T_J$ | -1.9    | -2.9  | -3.0 | -3.0  | mV/ $^{\circ}\text{C}$      |
| Thermal Resistance (Junction to Case)      | $RO_{J-C}$                |         | 1.1   |      |       | $^{\circ}\text{C}/\text{W}$ |

## IPC/JEDEC Moisture Sensitivity Level

Table 7 - IPC/JEDEC J-STD-20D.1 MSL Classification:

| Level | Soak Requirements |                                      |              |                                 |             |            |
|-------|-------------------|--------------------------------------|--------------|---------------------------------|-------------|------------|
|       | Floor Life        |                                      | Standard     |                                 | Accelerated |            |
|       | Time              | Conditions                           | Time (hrs)   | Conditions                      | Time (hrs)  | Conditions |
| 1     | Unlimited         | $\leq 30^{\circ}\text{C}/$<br>85% RH | 168<br>+5/-0 | $85^{\circ}\text{C}/$<br>85% RH | n/a         | n/a        |

Notes for Table 7:

- The standard soak time includes a default value of 24 hours for semiconductor manufacturer's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.

## Average Lumen Maintenance Projections

Lumen maintenance generally describes the ability of a lamp to retain its output over time. The useful lifetime for solid state lighting devices (Power LEDs) is also defined as Lumen Maintenance, with the percentage of the original light output remaining at a defined time period.

Based on long-term WHTOL testing, LED Engin projects that the LZ Series will deliver, on average, 70% Lumen Maintenance at 65,000 hours of operation at a forward current of 700 mA. This projection is based on constant current operation with junction temperature maintained at or below  $125^{\circ}\text{C}$ .

## Mechanical Dimensions (mm)

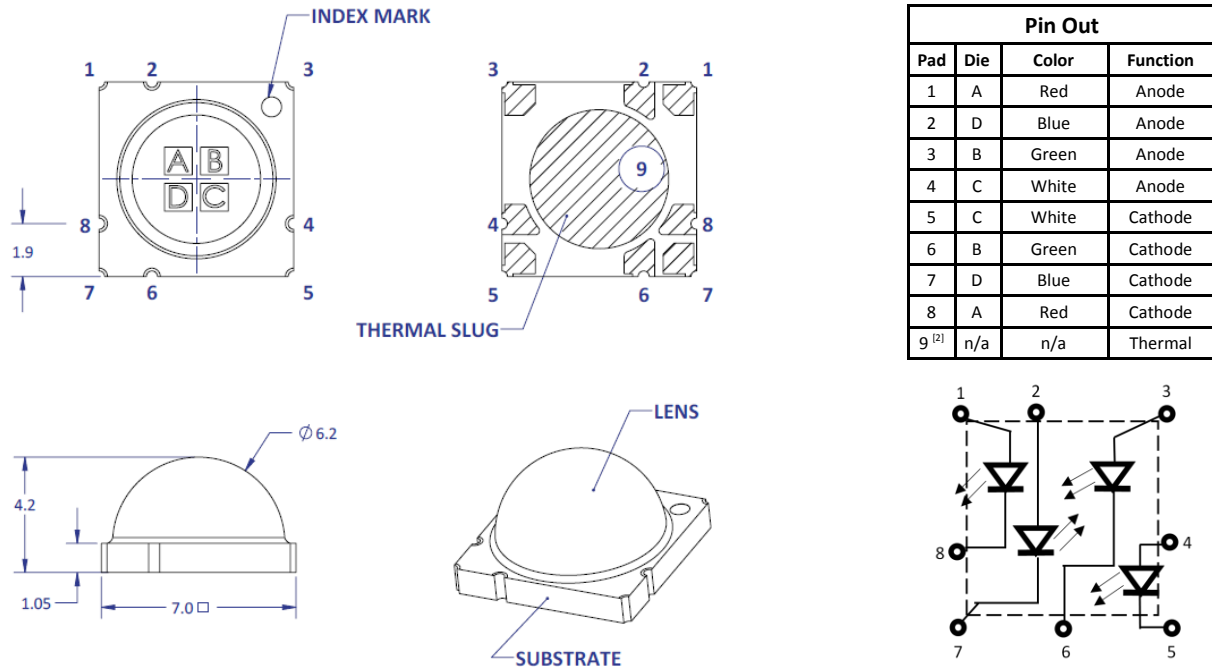


Figure 1: Package Outline Drawing.

Notes for Figure 1:

1. Unless otherwise noted, the tolerance =  $\pm 0.20$  mm.
2. Thermal contact, Pad 9, is electrically neutral.

## Recommended Solder Pad Layout (mm)

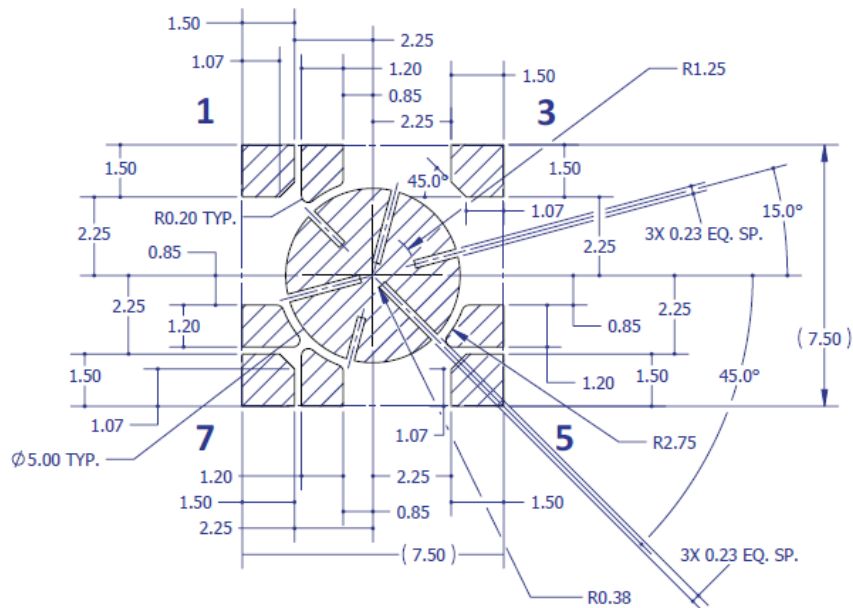


Figure 2a: Recommended solder pad layout for anode, cathode, and thermal pad.

Note for Figure 2a:

1. Unless otherwise noted, the tolerance =  $\pm 0.20$  mm.
2. This pad layout is "patent pending".

## Recommended Solder Mask Layout (mm)

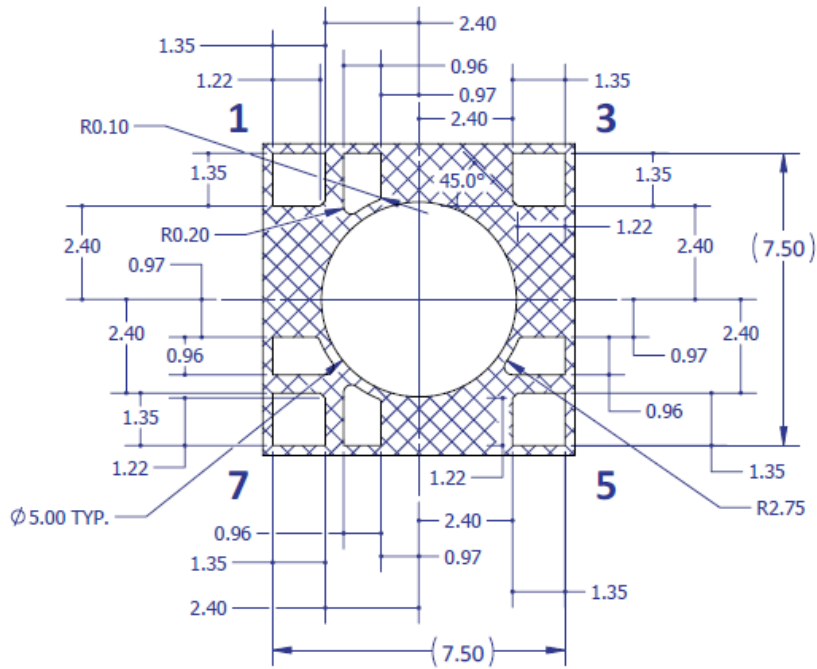


Figure 2b: Recommended solder mask opening (hatched area) for anode, cathode, and thermal pad.

Note for Figure 2b:

1. Unless otherwise noted, the tolerance =  $\pm 0.20$  mm.

## Reflow Soldering Profile

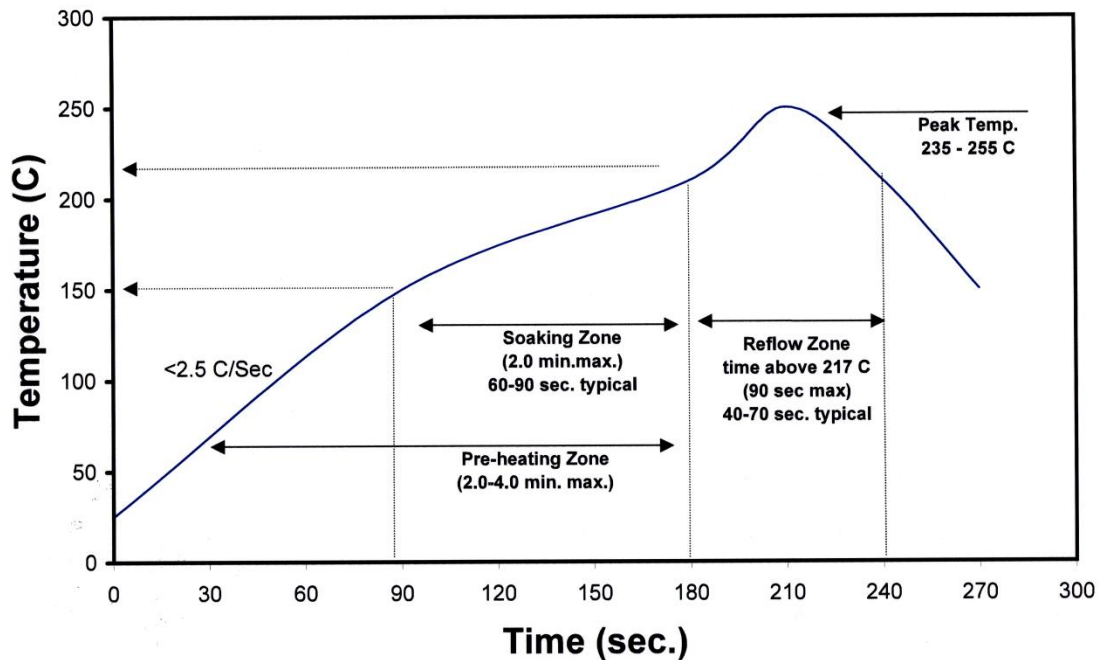


Figure 3: Reflow soldering profile for lead free soldering.



## Typical Radiation Pattern

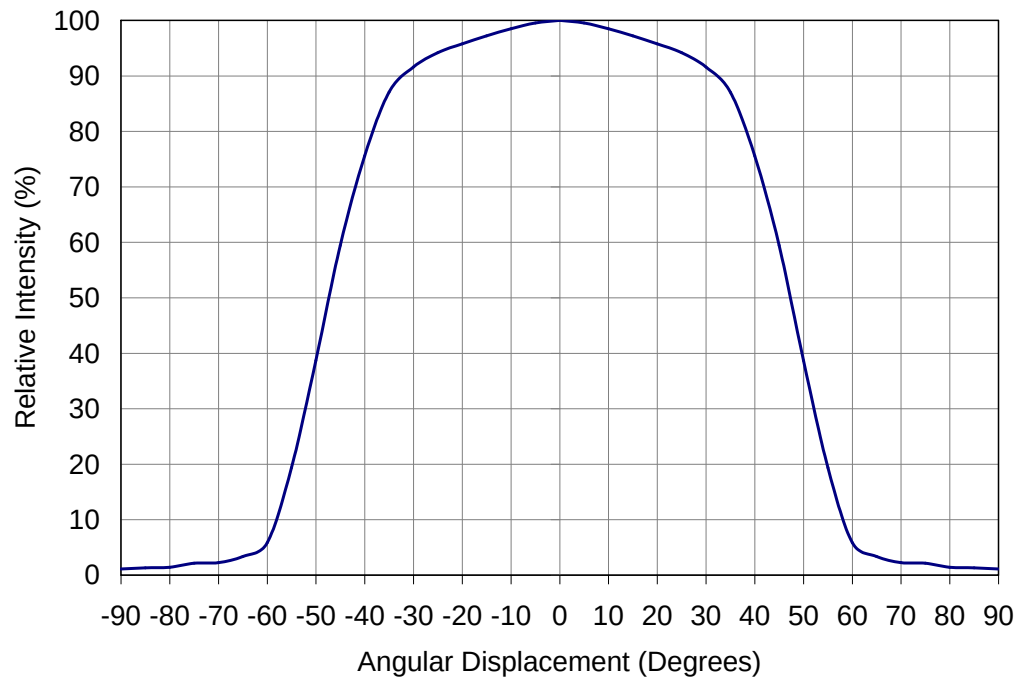


Figure 4: Typical representative spatial radiation pattern.

## Typical Relative Spectral Power Distribution

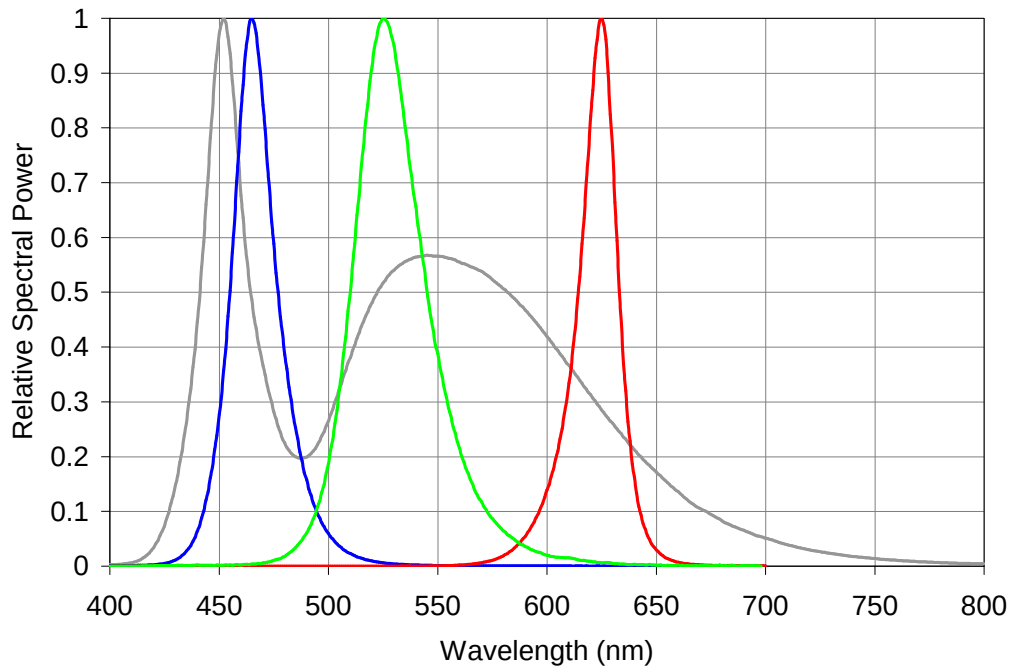


Figure 5: Typical relative spectral power vs. wavelength @  $T_c = 25^\circ\text{C}$ .

## Typical Dominant Wavelength Shift

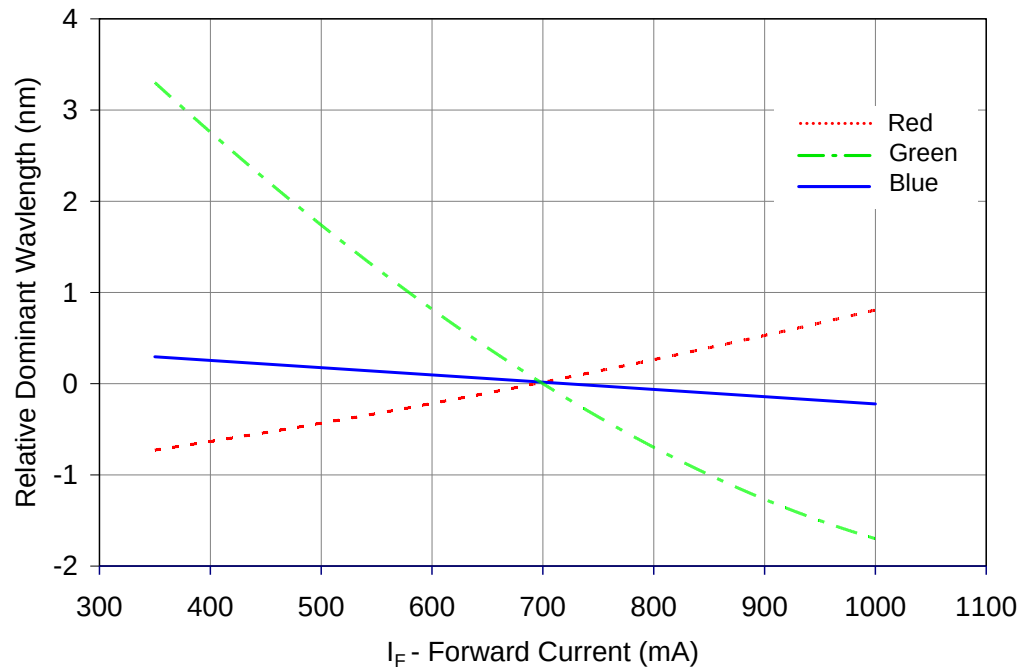


Figure 6: Typical dominant wavelength shift vs. forward current @  $T_C = 25^\circ\text{C}$ .

## Dominant Wavelength Shift over Temperature

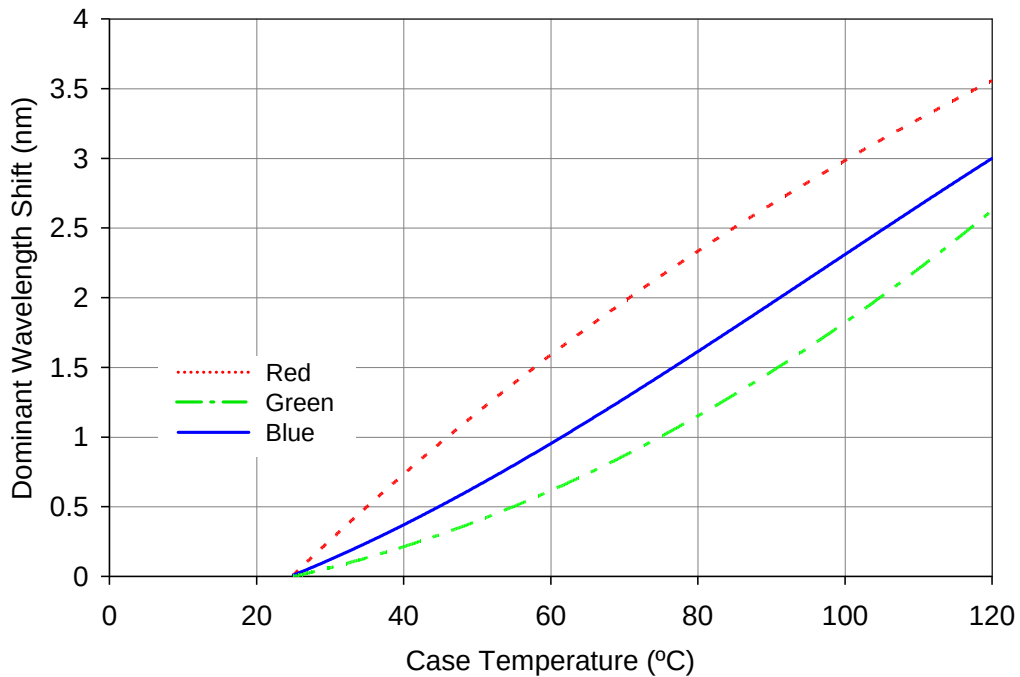


Figure 7: Typical dominant wavelength shift vs. case temperature.

## Typical Relative Light Output

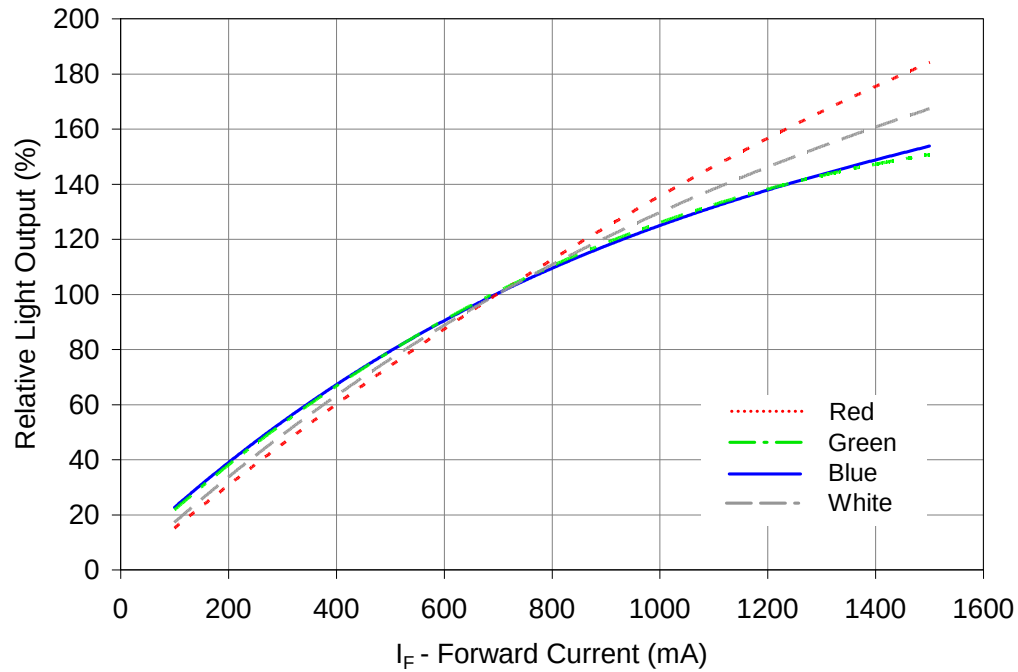


Figure 8: Typical relative light output vs. forward current @  $T_C = 25^\circ\text{C}$ .

## Typical Relative Light Output over Temperature

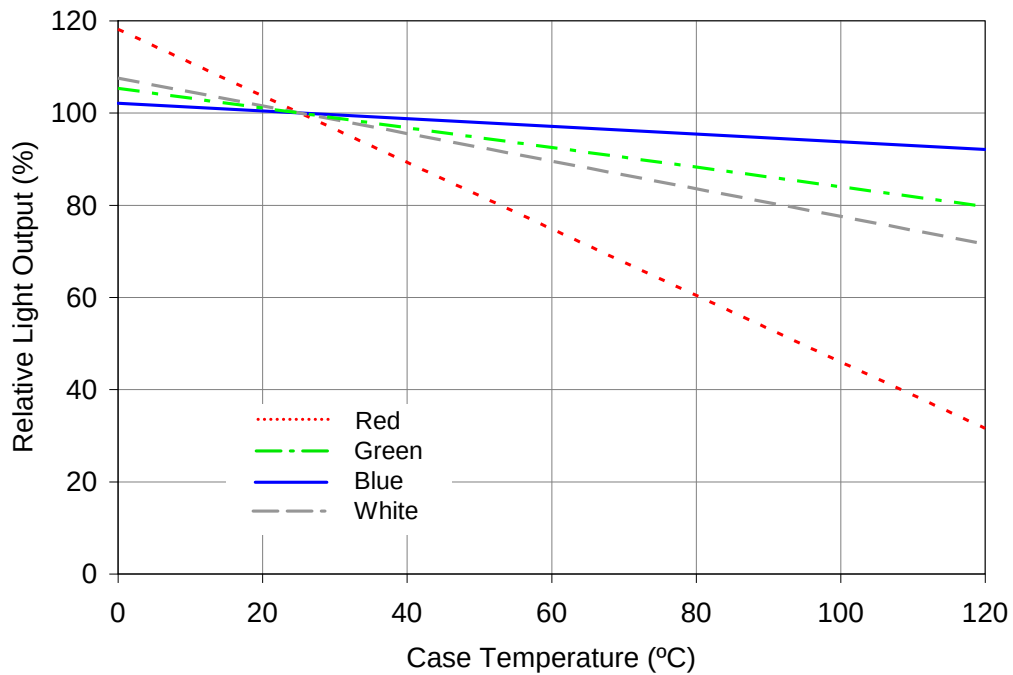


Figure 9: Typical relative light output vs. case temperature.

## Typical Forward Current Characteristics

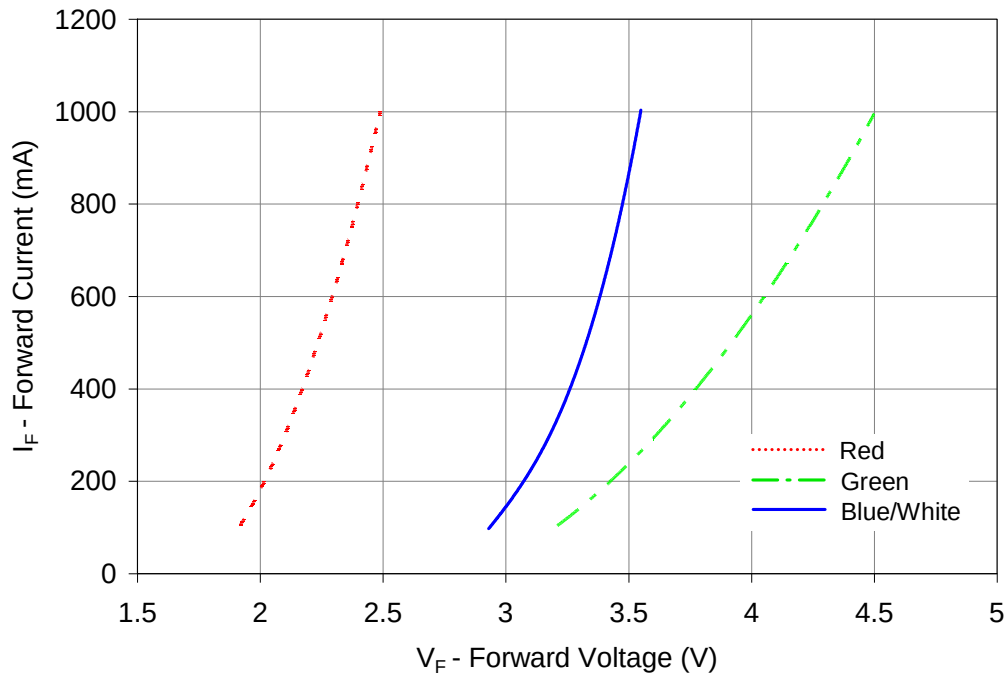


Figure 10: Typical forward current vs. forward voltage @  $T_c = 25^\circ\text{C}$ .

## Current De-rating

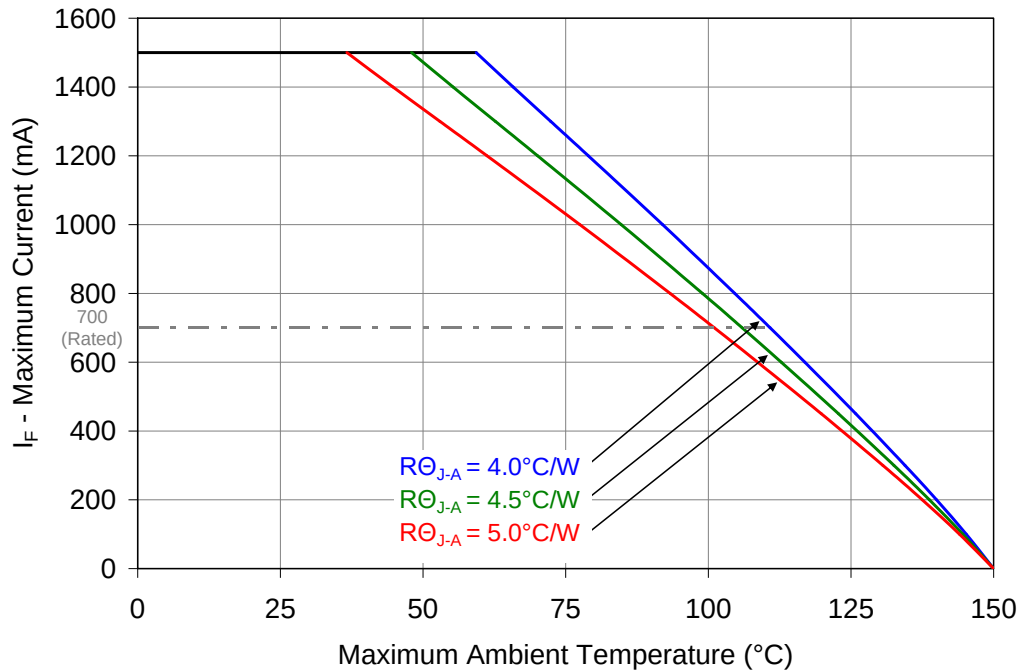


Figure 11: Maximum forward current vs. ambient temperature based on  $T_{J(\text{MAX})} = 150^\circ\text{C}$ .

Notes for Figure 11:

1. Maximum current assumes that all four LED dice are operating concurrently at the same current.
2.  $R\theta_{J-C}$  [Junction to Case Thermal Resistance] for the LZ4-00MD00 is typically  $1.1^\circ\text{C/W}$ .
3.  $R\theta_{J-A}$  [Junction to Ambient Thermal Resistance] =  $R\theta_{J-C} + R\theta_{C-A}$  [Case to Ambient Thermal Resistance].

## Emitter Tape and Reel Specifications (mm)

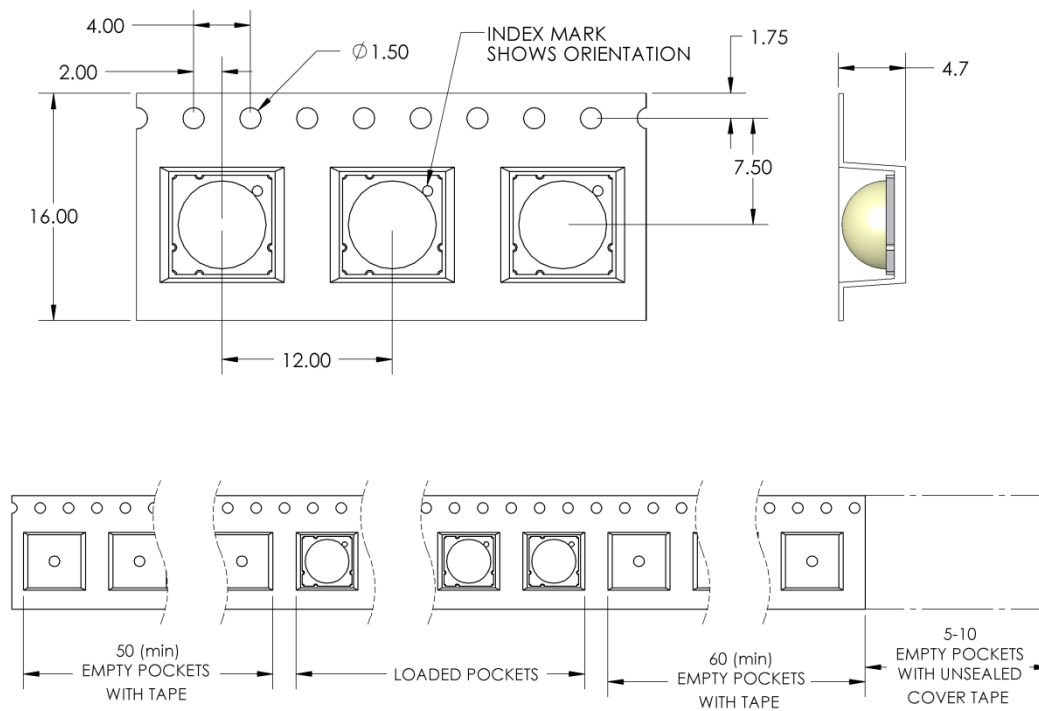


Figure 12: Emitter carrier tape specifications (mm).

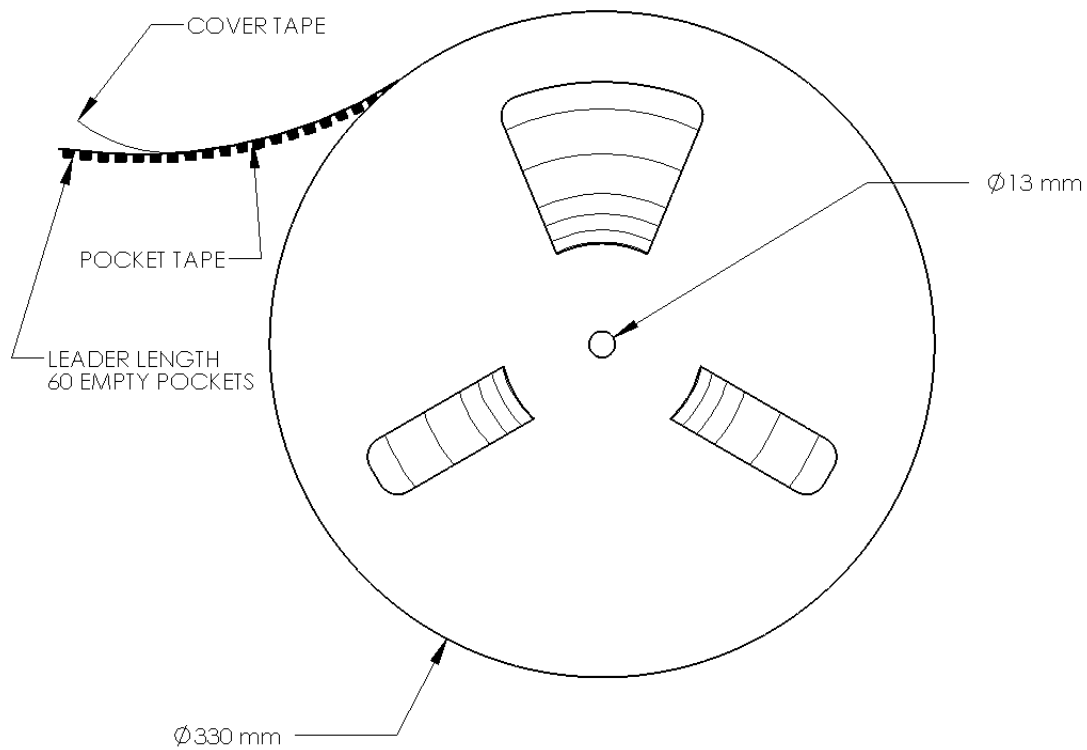


Figure 13: Emitter reel specifications (mm).

# LZ4 MCPCB Family

| Part number | Type of MCPCB | Diameter (mm) | Emitter + MCPCB Thermal Resistance (°C/W) | Typical $V_f$ (V) | Typical $I_f$ (mA) |
|-------------|---------------|---------------|-------------------------------------------|-------------------|--------------------|
| LZ4-6xxxxxx | 4-channel     | 19.9          | $1.1 + 0.2 = 1.3$                         | 2.2 – 3.4         | 700                |

## Mechanical Mounting of MCPCB

- MCPCB bending should be avoided as it will cause mechanical stress on the emitter, which could lead to substrate cracking and subsequently LED dies cracking.
- To avoid MCPCB bending:
  - Special attention needs to be paid to the flatness of the heat sink surface and the torque on the screws.
  - Care must be taken when securing the board to the heat sink. This can be done by tightening three M3 screws (or #4-40) in steps and not all the way through at once. Using fewer than three screws will increase the likelihood of board bending.
  - It is recommended to always use plastics washers in combinations with the three screws.
  - If non-taped holes are used with self-tapping screws, it is advised to back out the screws slightly after tightening (with controlled torque) and then re-tighten the screws again.

## Thermal interface material

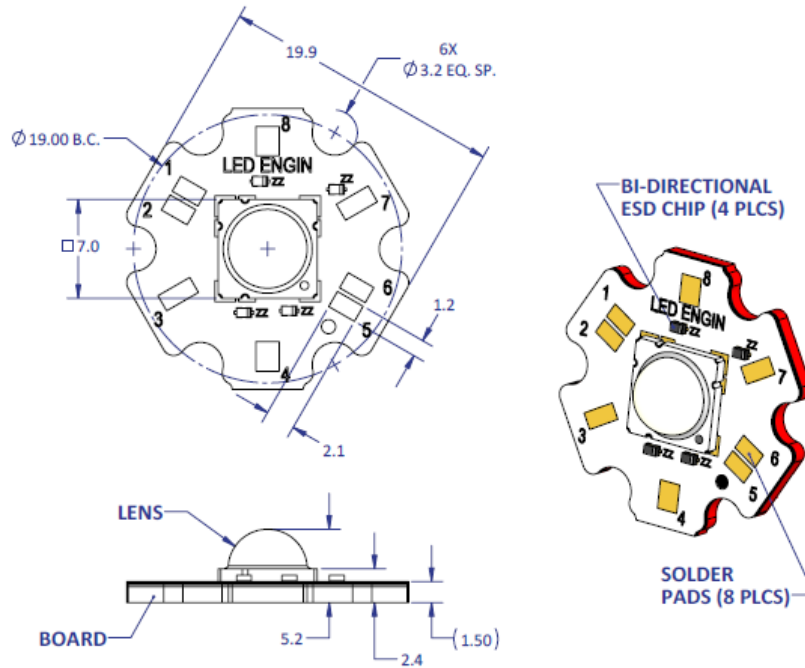
- To properly transfer heat from LED emitter to heat sink, a thermally conductive material is required when mounting the MCPCB on to the heat sink.
- There are several varieties of such material: thermal paste, thermal pads, phase change materials and thermal epoxies. An example of such material is Electrolube EHTC.
- It is critical to verify the material's thermal resistance to be sufficient for the selected emitter and its operating conditions.

## Wire soldering

- To ease soldering wire to MCPCB process, it is advised to preheat the MCPCB on a hot plate of 125-150°C. Subsequently, apply the solder and additional heat from the solder iron will initiate a good solder reflow. It is recommended to use a solder iron of more than 60W.
- It is advised to use lead-free, no-clean solder. For example: SN-96.5 AG-3.0 CU 0.5 #58/275 from Kester (pn: 24-7068-7601)

# LZ4-6xxxxx

4 channel, Standard Star MCPCB (4x1) for LZ4 pin aligned emitter Dimensions (mm)



## Notes:

- Unless otherwise noted, the tolerance =  $\pm 0.2$  mm.
- Slots in MCPCB are for M3 or #4-40 mounting screws.
- LED Engin recommends plastic washers to electrically insulate screws from solder pads and electrical traces.
- LED Engin recommends using thermal interface material when attaching the MCPCB to a heatsink.
- The thermal resistance of the MCPCB is:  $R_{\theta C-B} 0.2^{\circ}\text{C/W}$

## Components used

MCPCB: MHE-301 (Rayben)  
ESD chips: VBUS05L1-DD1 (Vishay, for 1 LED die)

| Pad layout |           |            |           |
|------------|-----------|------------|-----------|
| Ch.        | MCPCB Pad | String/die | Function  |
| 1          | 1         | 1/A        | Cathode - |
|            | 8         |            | Anode +   |
| 2          | 2         | 2/D        | Cathode - |
|            | 7         |            | Anode +   |
| 3          | 3         | 3/B        | Cathode - |
|            | 6         |            | Anode +   |
| 4          | 4         | 4/C        | Cathode - |
|            | 5         |            | Anode +   |

## Company Information

LED Engin, Inc., based in California's Silicon Valley, specializes in ultra-bright, ultra compact solid state lighting solutions allowing lighting designers & engineers the freedom to create uncompromised yet energy efficient lighting experiences. The LuxiGen™ Platform — an emitter and lens combination or integrated module solution, delivers superior flexibility in light output, ranging from 3W to 90W, a wide spectrum of available colors, including whites, multi-color and UV, and the ability to deliver upwards of 5,000 high quality lumens to a target. The small size combined with powerful output allows for a previously unobtainable freedom of design wherever high-flux density, directional light is required. LED Engin's packaging technologies lead the industry with products that feature lowest thermal resistance, highest flux density and consummate reliability, enabling compact and efficient solid state lighting solutions.

LED Engin is committed to providing products that conserve natural resources and reduce greenhouse emissions.

LED Engin reserves the right to make changes to improve performance without notice.

Please contact [sales@ledengin.com](mailto:sales@ledengin.com) or (408) 922-7200 for more information.





Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

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- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
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- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.